



Board Level Shielding
Design & Fabrication

Item No:

MS412-10

Description:

**DRAWN RF SHIELD
FRAME + COVER**

Material:

**TIN STEEL
(See Note 1-2)**

Note: (1) TS275E 8.4/8.4 (2) Electrolytic Tin Plate As Per EN 10202:2001 Min Tin Thickness 3.5 μ m
(3) General tolerance ± 0.2 mm Non Dimensioned items remain Masach Technologies LTD property.



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MMGS / Print 1:1 / A4